IPC ASSOCIATION CONNECTELECTRONICS INDUSTRI	Material Composi © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfc Information				
Supplier Infor									,						
Company name*			Company unique ID			Unique	Unique ID Authority					Response Date*			
onsemi			!									2024-05-03			
Contact Name		Title - Contact			Phone -	Phone - Contact*					Email - Contact*				
Product-Env-Ste	wards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
uthorized Repre	esentative*		Title - Representative			Phone -	Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product				Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Reque	ster Item Number			Mfr Item Name		Effecti	ve Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
				onous Rectifier Control Converter	er 2024-0	05-03	PH1		,	77.422	mg	Each			
<b>Ianufacturin</b>	g Proccess Informatio	n													
Terminal Plating / Grid Array Material Termin			rminal Base Alloy J-STD-020 MSL I		-STD-020 MSL Rating	Pe	Peak Process Body Temperature   Max Time at Pe		e Max Time at Peak	k Temperature Number of Reflow Cycles					
Matte Tin (Sn) - annealed			CU Alloy 1			26	50	C 30		30	secon	ds 3			
omments															
vel 1 - maximun	n time at peak temperature	during sold	lering is 10-3	0 seconds			·-			·		·	·		
or more informa	ntion regarding material co	mposition p	lease refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.8396	mg	Supplier	Silicon (Si)	7440-21-3		1.8396	mg
Die Attach	0.1651	mg		Epoxy resin	proprietary data		0.0215	mg
			Supplier	Silver (Ag)	7440-22-4		0.0578	mg
			Supplier	Acrylic resins	Proprietary Data		0.0281	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0578	mg
Lead Frame	30.24		Supplier	Silver (Ag)	7440-22-4		1.5513	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0544	mg
			Supplier	Iron (Fe)	7439-89-6		0.7439	mg
			Supplier	Copper (Cu)	7440-50-8		27.848	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0423	mg
Mold Compound-Black	42.7027		Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'-tetramethylbiphenyl	85954-11-6		1.9216	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2135	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		39.2865	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.2811	mg
Plating	2.2804	mg	Supplier	Tin (Sn)	7440-31-5		2.2804	mg
Wire Bond - Au	0.1942	mg	Supplier	Gold (Au)	7440-57-5		0.1942	mg